

PRODUCT NUMBER

95609-XXXLF

PLATING

- 0 = 0.20µm Au/GXT
- 1 = 0.76µm Au/GXT
- 3 = 0.38µm Au/GXT
- 5 = 0.38µm GXT
- 6 = 0.76µm GXT

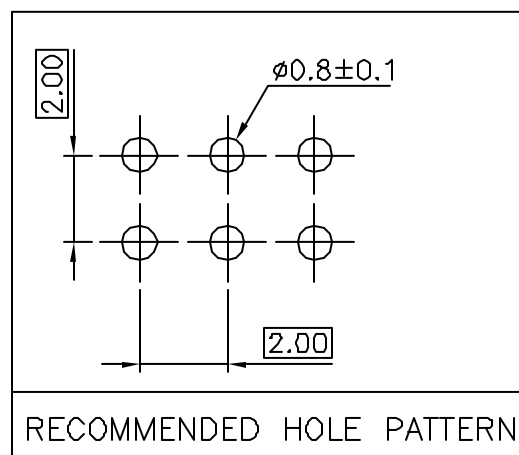
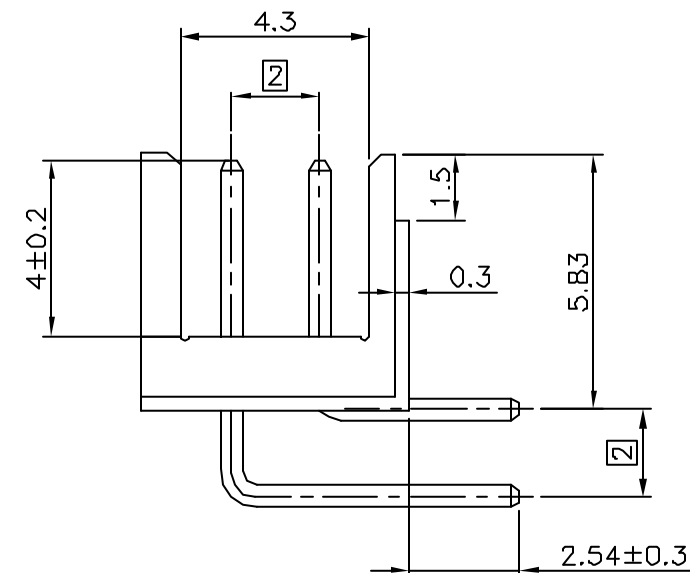
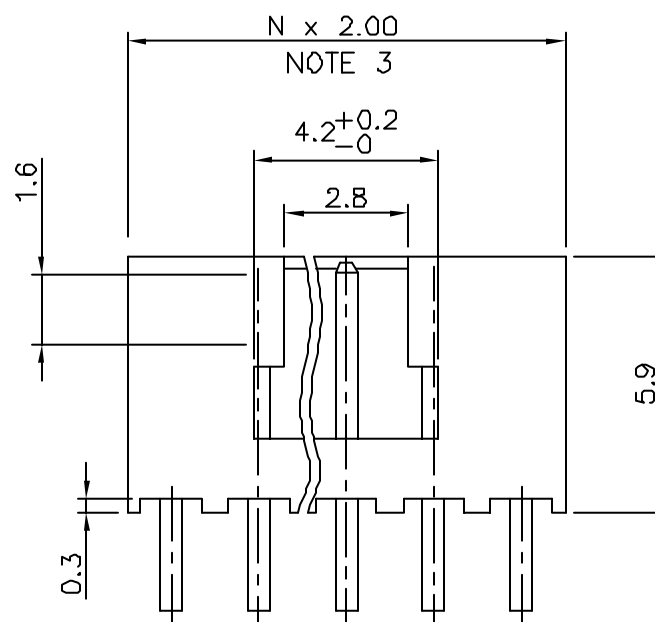
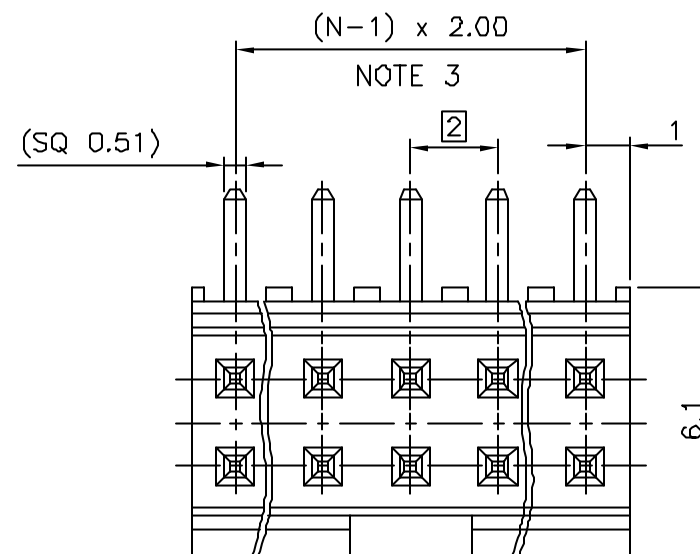
WHEN REQUIRED, ADD SUFFIX LETTER "LF"  
INDICATES THE PRODUCT IS RoHS  
COMPATIBLE, SEE NOTE 6 & 7

TOTAL NB OF POSITIONS, 08 TO 34

UNDERPLATING 1.27µm Ni MIN

NOTES:

1. MATERIAL HOUSING: HIGH TEMP. THERMOPLASTIC  
UL 94V-0, COLOR CREAM
2. MATERIAL TERMINAL: COPPER ALLOY
3. TO DETERMINE DIMENSIONS:  
N = NUMBER OF POSITIONS PER ROW
4. 7N MIN. PIN RETENTION IN EITHER DIRECTION.
5. STANDARD PACKAGING IN POLYBAGS.
6. 95609-XXXLF IS SIMILAR TO 95609-XXX, THE SUFFIX "LF"  
IS ADDED FOR EASY LEAD FREE IDENTIFICATION
7. RoHS COMPATIBLE PRODUCT SPECIFICATIONS
  - a - MANUFACTURING PROCESS COMPATIBILITY
    - THE HOUSING WILL WITHSTAND EXPOSURE TO  
260°C ±5°C SOLDER BATH TEMPERATURE FOR  
5 SECONDS IN A WAVE SOLDER APPLICATION  
WITH A 1.6mm MIN THICK CIRCUIT BOARD.
  - b - LABELLING:
    - MEETS PACKAGING SPECS AS PER GS-14-920
  - c - THIS PRODUCT MEETS EUROPEAN DIRECTIVES  
AND OTHER COUNTRY REGULATIONS AS DISCRIBED  
IN GS-22-008.



mat'l. code		surface		tolerance		projection		product family	
SEE NOTES		ISO 1302 ✓		ISO 406 ISO 101		mm		MINITEK HEADER	
ltr	ecn no	dr	date	tolerances unless otherwise specified		mm		title	
C	F05-0128	LMU	05.02.21	angles	.X ±0.3	mm		SHR HEADER	
D	F06-0210	LMU	06.07.04	linear	.XX ±0.13	mm		2.00mm TMT R/A	
E	F08-0145	ELA	15.04.08	±2'	.XXX ±0.05	scale 7:1		dwg no	
				dr	L.MULIN	02.06.19		sheet 1 of 1	
				engr	J.COMPAGNON	02.06.19		size	
				chr				95609	
				appd	JMC	02.06.19		A3	
sheet index		revision sheet						type	
								CUSTOMER Drawing	